



Form Type	Distribute	Version	2.0	Ref	IPC 1752A	Sectionals	Material Info	Subsectionals	D, A
Supplier Information									
Company Name	TE Connectivity	Request Document ID		Contact Name	Olson, Joseph R	Contact Title	Prod Sustaining Engineer		
Company Unique ID	TE Connectivity	Response Date	2015-07-25	Contact Email	jrolson@te.com				
Contact Phone Number	1-717-592-4423								
Legal Statement									
Supplier Acceptance	true								
Legal Statement									
The information provided in this document is based upon reasonable inquiry of our suppliers. This information is subject to change. This information does not in any way modify existing purchase specifications or existing contractual or other agreements terms between TE Connectivity (or its affiliated companies) and its customers.									
Product									
Manufacturer Item number	104074-4	Amount	1712.572283	Version	-	Identity			
Manufacturer Item Name	20 SYSTEM 50 HDR SRRA SHRD	Weight Uom	mg	Mfr Site		Authority			
Date		UOM	Each						
EUroHS-0508	Product(s) does not meet EU RoHS requirements and is not under exemptions								
ChinaRoHS-0508	Product(s) is NOT eligible for marking with the e code under China's Measures for Administration of the control of pollution by Electronic Information Products								
EUREACH-1214	REACH Candidate Substances of Very High Concern ARE NOT Yet Reviewed								
Product Disclosure									
Sub-Item/Material/Substance	Level	Name	Substance Category	Substance CAS	Substance Concentration	Quantity	Mass per Unit	UOM	Exemption
Sub-Item	1	SYSTEM 50 SDR CLIP 150 SN-PB				2.0	33.0005	mg	
Material	2	Tin-Lead Plate				2.0	2.26	mg	
Substance	3	Tin	Supplier	7440-31-5	92.3	2.0	2.08598	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.7	2.0	0.01582	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	7.0	2.0	0.1582	mg	
Material	2	Nickel Plate				2.0	0.9965	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	2.0	0.001993	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	2.0	9.965E-4	mg	
Substance	3	Nickel	Nickel	7440-02-0	99.7	2.0	0.99351	mg	
Material	2	Phos Bronze				2.0	29.744	mg	
Substance	3	Copper	Supplier	7440-50-8	94.6835	2.0	28.16266	mg	
Substance	3	Manganese	Supplier	7439-96-5	0.02	2.0	0.0059488	mg	
Substance	3	Chromium	Supplier	7440-47-3	0.01	2.0	0.0029744	mg	
Substance	3	Tin	Supplier	7440-31-5	4.5	2.0	1.33848	mg	
Substance	3	Arsenic	Supplier	7440-38-2	0.015	2.0	0.0044616	mg	
Substance	3	Iron	Supplier	7439-89-6	0.1	2.0	0.029744	mg	
Substance	3	Antimony	Supplier	7440-36-0	0.01	2.0	0.0029744	mg	
Substance	3	Beryllium	Supplier	7440-41-7	0.0010	2.0	2.9744E-4	mg	
Substance	3	Zinc	Supplier	7440-66-6	0.3	2.0	0.089232	mg	
Substance	3	Phosphorus	Supplier	7723-14-0	0.1	2.0	0.029744	mg	
Substance	3	Cobalt	Supplier	7440-48-4	0.1	2.0	0.029744	mg	
Substance	3	Cadmium	Cadmium/Cadmium Compounds	7440-43-9	0.01	2.0	0.0029744	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.05	2.0	0.014872	mg	
Substance	3	Nickel	Nickel	7440-02-0	0.1	2.0	0.029744	mg	
Substance	3	Mercury	Mercury/Mercury Compounds	7439-97-6	5.0E-4	2.0	1.4872E-4	mg	
Sub-Item	1	SYSTEM 50 POST PLTD 30 DPLX				20.0	12.39179	mg	
Material	2	Gold Plate				20.0	0.00587	mg	

Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.3	20.0	1.761E-5	mg	
Substance	3	Gold	Supplier	7440-57-5	99.7	20.0	0.00585239	mg	
Material	2	Gold Plate				20.0	0.01032	mg	
Substance	3	Gold	Supplier	7440-57-5	99.7	20.0	0.01028904	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-0909	0.3	20.0	3.096E-5	mg	
Material	2	Tin-Lead Plate				20.0	0.149	mg	
Substance	3	Tin	Supplier	7440-31-5	92.3	20.0	0.13753	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.7	20.0	0.001043	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	7.0	20.0	0.01043	mg	
Material	2	Nickel Plate				20.0	0.004413	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	20.0	1.0E-5	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	20.0	1.0E-5	mg	
Substance	3	Nickel	Nickel	7440-02-0	99.7	20.0	0.00439976	mg	
Material	2	Brass				20.0	12.222187	mg	
Substance	3	Tin	Supplier	7440-31-5	0.1	20.0	0.01222219	mg	
Substance	3	Copper	Supplier	7440-50-8	64.0	20.0	7.8222	mg	
Substance	3	Iron	Supplier	7439-89-6	0.05	20.0	0.00611109	mg	
Substance	3	Beryllium	Supplier	7440-41-7	0.0010	20.0	1.2222E-4	mg	
Substance	3	Arsenic	Supplier	7440-38-2	0.01	20.0	0.00122222	mg	
Substance	3	Cobalt	Supplier	7440-48-4	0.1	20.0	0.01222219	mg	
Substance	3	Manganese	Supplier	7439-96-5	0.1	20.0	0.01222219	mg	
Substance	3	Zinc	Supplier	7440-66-6	35.2085	20.0	4.30325	mg	
Substance	3	Antimony	Supplier	7440-36-0	0.01	20.0	0.00122222	mg	
Substance	3	Chromium	Supplier	7440-47-3	0.01	20.0	0.00122222	mg	
Substance	3	Aluminum	Supplier	7429-90-5	0.05	20.0	0.00611109	mg	
Substance	3	Nickel	Nickel	7440-02-0	0.3	20.0	0.03666656	mg	
Substance	3	Cadmium	Cadmium/Cadmium Compounds	7440-43-9	0.01	20.0	0.00122222	mg	
Substance	3	Mercury	Mercury/Mercury Compounds	7439-97-6	5.0E-4	20.0	6.111093E-5	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.05	20.0	0.00611109	mg	
Sub-Item	1	20 SYSTEM 50 HDR HSG SR LATCH				1.0	1398.735483	mg	
Material	2	LIQUID CRYSTAL PLOYMER				1.0	1398.735483	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-0909	3.0	1.0	41.96206	mg	
Substance	3	Liquid Crystal Polymer - ISO 1043-1 Term LCP	Supplier	1043-1-LCP	67.0	1.0	937.15277	mg	
Substance	3	Glass, oxide, chemicals	Supplier	65997-17-3	30.0	1.0	419.62064	mg	